

REMARKS

Summary

Claims 1-23 were pending, and all of the Claims were rejected in the Office action. Claims 1, 4, 13, and 23 have been amended by this paper. The Applicants respectfully traverse the rejection of the claims, as set forth below. According to MPEP Section 1453, only the amended claims are presented in the previous section. However, a complete list of claims is also attached at the end of this paper for the Examiner's convenience.

Double Patenting Rejection

Terminal Disclaimer

The Applicants express appreciation to the Examiner for calling attention to the error in the patent number referred to in the Terminal Disclaimer. A corrected terminal disclaimer is appended. The Consent of the Assignees under 37 CFR §3.73, dated June 12, 2006, has previously been filed, and the terminal disclaimer fee paid.

Claim Rejections under 35 U.S.C. § 102 and 35 U.S.C. § 103

Claims 1, 6-7 and 10 were rejected under 35 U.S.C. § 102(b) as being anticipated by Kagatsume et al. (US 4,908,095; "Kagatsume").

Claims 2-5 were rejected under 35 U.S.C. § 103(a) as being obvious over Kagatsume.

Claims 8, 13, and 22- 23 were rejected under 35 U.S.C. § 103(a) as being obvious over Kagatsume in view of the Admitted Prior Art (APA).

Claims 9, 11-12, 14-21 and 23 were rejected under 35 U.S.C. § 103(a) as being obvious over Kagatsume in view of the Admitted Prior Art (APA) as applied to Claims 8, 13, and 22-23 above and further in view of Kawakami et al. (JP 06-333879; "Kawakami").

Claims 1-23 were rejected under 35 U.S.C. § 103(a) as being obvious over the Admitted Prior Art (APA), in view of Kawakami, Sakai et al. (JP 10-032171;"Sakai"), or Kagatsume

Claim 1 recites plasma treatment equipment configured such that "the chamber wall of the chamber and the susceptor electrode are AC shorted to each other by a plurality of metal plates." The cited reference does not teach or suggest at least this limitation.

The Examiner alleges that Kagatsume teaches this limitation by disclosing a side wall of the chamber and the susceptor electrode are AC shorted to each other by a conductive metal element 27 (Kagatsume, FIG. 5 and lines 52-57, section 5). However, the metal element 27 is a bellows. The metal element 27 is not a metal plate. Therefore, Kagatsume does not teach that the chamber wall of the chamber and the susceptor electrode are AC shorted to each other by a plurality of metal plates.

The Examiner alleges that the shape of the shorting element is a matter of choice. Applicant respectfully submits that the configuration of "a plurality of plates" is significant from findings shown in FIG. 4A, FIG. 4B, and FIG. 7 of the present application as shown below. The inductance decreases as the number of metal plates increases. The decreased inductance will significantly increase the power consumption efficiency. Therefore, the particular configuration of the claimed "a plurality of plates" is significant and is not taught or suggested by the cited references. Claim 1 is allowable for at least this reason.

FIG. 4A

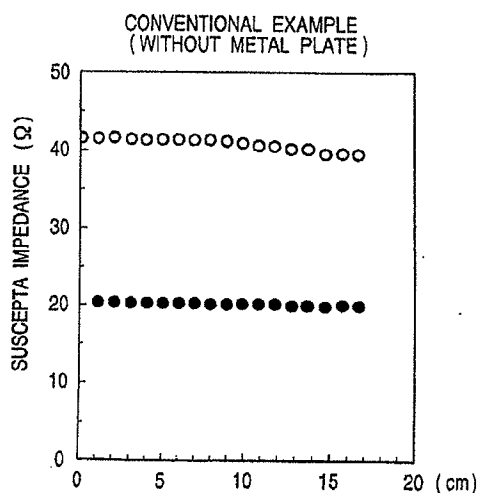


FIG. 4B

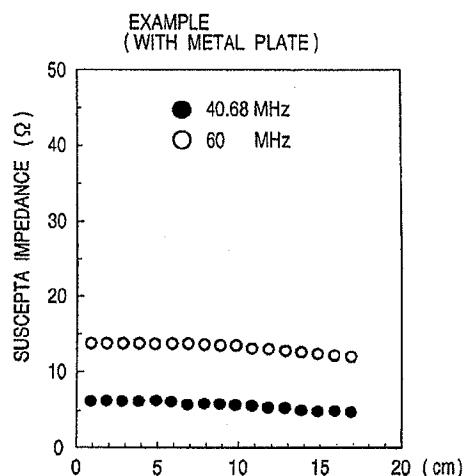
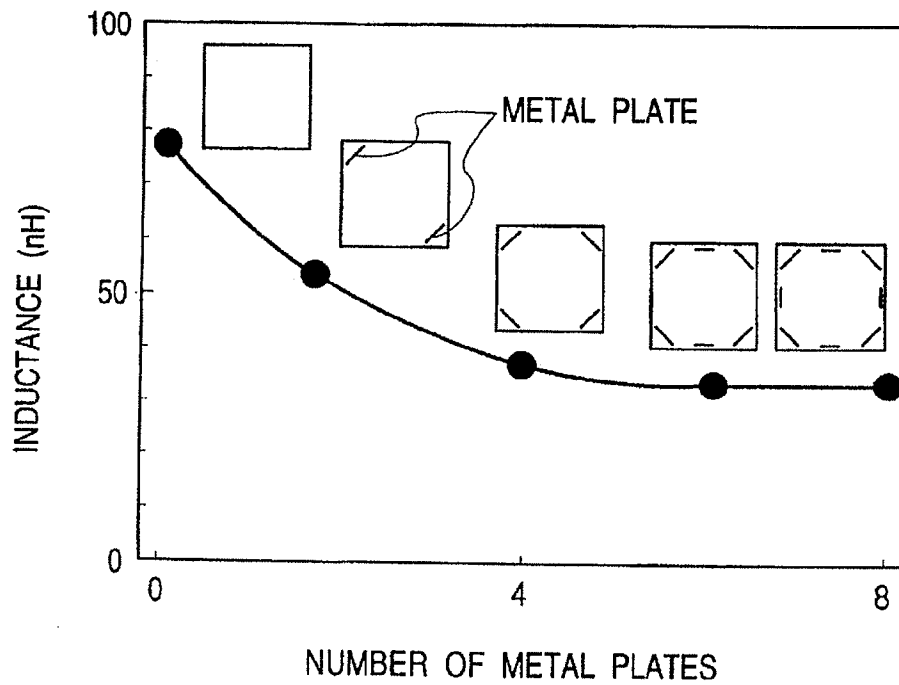


FIG. 7



Accordingly, claims 13 and 23 are allowable for similar reasons. Claims 2-10, 14, and 17-19 are allowable either as claims dependent on an allowable base claim.

Listing of Claims

What is claimed is:

1. (Twice Amended) A plasma treatment equipment having a chamber for performing plasma treatment, the plasma treatment equipment comprising:
a plasma excitation electrode to which a power for plasma excitation is supplied,
the plasma excitation electrode being provided in the chamber; and
a susceptor electrode that is opposed to the plasma excitation electrode provided in the chamber, the susceptor electrode having the same DC potential as that of a chamber wall of the chamber, the susceptor electrode being an electrode into which a high frequency electric current based on the power for plasma excitation flows after passing through a plasma space;
wherein the chamber wall of the chamber and the susceptor electrode are AC shorted to each other by a plurality of metal plates, the susceptor electrode is connected to the chamber wall of the chamber by a bellows provided in the chamber, the plurality of metal plates are disposed so as to be electrically parallel with the bellows [Plasma treatment equipment in which a chamber wall and a susceptor electrode having the same DC potential are AC shorted to each other].
2. (Original) The plasma treatment equipment according to claim 1, wherein said chamber wall and said susceptor electrode are shorted to each other at a location that is within a distance shorter than 500 mm from a side wall of the chamber wall.
3. (Original) The plasma treatment equipment according to claim 1, wherein said susceptor electrode is shorted to said chamber wall at a short point on a bottom wall of the chamber wall, said short point being located within a distance shorter than 500 mm from a side wall of the chamber wall as measured along the bottom wall.
4. (Amended) The plasma treatment equipment according to claim 3, wherein [said susceptor electrode is shorted to said chamber wall by a metal plate, said] each

metal plate [being] is connected between the short point on the bottom wall and a second short point on a shield of the susceptor electrode.

5. (Previously Presented) The plasma treatment equipment according to claim [3]4, wherein the said metal plate is inclined with respect to the bottom wall, and an angle formed between said metal plate and the bottom wall is less than 45 degrees.

6. (Original) The plasma treatment equipment according to claim 1, wherein said chamber wall and said susceptor electrode are shorted at a plurality of short points.

7. (Original) The plasma treatment equipment according to claim 6, wherein the plurality of short points are disposed approximately symmetrically with respect to a center of said susceptor electrode.

8. (Original) The plasma treatment equipment according to claim 6, wherein the plurality of short points are disposed approximately symmetrically with respect to a center of a shield of said susceptor electrode.

9. (Original) The plasma treatment equipment according to claim 1, wherein said susceptor electrode comprises a shield having the same DC potential as said chamber wall, and said shield and said chamber wall are AC shorted to each other.

10. (Original) The plasma treatment equipment according to claim 1, wherein said susceptor electrode is shorted to a side wall of the chamber wall.

11. (Original) Plasma treatment equipment comprising:
a plasma chamber having a bottom wall and a side wall; and
a susceptor electrode disposed within the plasma chamber, said susceptor electrode comprising a generally planar shaped electrode portion oriented substantially parallel to the bottom wall of the plasma chamber, said susceptor electrode further comprising a generally planar shaped shield disposed adjacent to said electrode

portion, said shield being located between said electrode portion and the bottom wall of the plasma chamber,

wherein the bottom wall of the plasma chamber and the shield of the susceptor electrode have the same DC potential,

wherein the bottom wall of the plasma chamber and the shield of the susceptor electrode are AC shorted to each other by a metal plate, said metal plate having a first end connected to a first short point on the shield and a second end connected to a second short point on the bottom wall of the chamber, and

wherein the second short point is located within 500 mm of the side wall of the plasma chamber.

12. (Original) Plasma treatment equipment comprising:

a plasma chamber having a bottom wall and a side wall; and
a susceptor electrode disposed within the plasma chamber, said susceptor electrode comprising a generally planar shaped electrode portion oriented substantially parallel to the bottom wall of the plasma chamber, said susceptor electrode further comprising a generally planar shaped shield disposed adjacent to said electrode portion, said shield being located between said electrode portion and the bottom wall of the plasma chamber,

wherein the side wall of the plasma chamber and the shield of the susceptor electrode have the same DC potential, and

wherein the side wall of the plasma chamber and the shield of the susceptor electrode are AC shorted to each other by a metal plate, said metal plate having a first end connected to a first short point on the shield and a second end connected to a second short point on the side wall of the chamber.

13. (Twice Amended) A plasma treatment equipment having a chamber for performing plasma treatment, the plasma treatment equipment comprising:

a plasma excitation electrode to which a power for plasma excitation is supplied, the plasma excitation electrode being provided in the chamber;

a susceptor electrode that is opposed to the plasma excitation electrode provided in the chamber; and

an electrode shield of the susceptor electrode in the chamber,

wherein at least one of the susceptor electrode and the electrode shield thereof has the same DC potential as that of a chamber wall of the chamber,

the susceptor electrode being an electrode into which a high frequency electric current based on the power for plasma excitation flows after passing through a plasma space,

the chamber wall of the chamber and at least one of the susceptor electrode and the electrode shield thereof are AC shorted to each other by a plurality of metal plates, and

the susceptor electrode is connected to the chamber wall of the chamber by a bellows provided in the chamber, the plurality of metal plates are disposed so as to be electrically parallel with the bellows.

14. (Previously Presented) The plasma treatment equipment according to claim 13, wherein the electrode shield of the susceptor electrode has the same DC potential as that of the chamber wall of the chamber, and the chamber wall of the chamber and the electrode shield of the susceptor electrode are AC shorted to each other.

15. (Previously Presented) The plasma treatment equipment according to claim 14, wherein said chamber wall and said electrode shield are shorted to each other at a location that is within a distance shorter than 500 mm from a side wall of the chamber wall.

16. (Previously Presented) The plasma treatment equipment according to claim 15, wherein said electrode shield is shorted to said chamber wall at a short point

on a bottom wall of the chamber wall, said short point being located within a distance shorter than 500 mm from a side wall as measured along the bottom wall.

17. (Previously Presented) The plasma treatment equipment according to claim 14, wherein said chamber wall and said electrode shield are shorted at a plurality of short points.

18. (Previously Presented) The plasma treatment equipment according to claim 17, wherein the plurality of short points are disposed approximately symmetrically with respect to a center of said electrode shield.

19. (Previously Presented) The plasma treatment equipment according to claim 14, wherein said electrode shield is shorted to a side wall of the chamber wall.

20. (Previously Presented) The plasma treatment equipment according to claim 16, wherein said electrode shield is shorted to said chamber wall by a metal plate, said metal plate being connected between the short point on the bottom wall and a second short point on the electrode shield.

21. (Previously Presented) The plasma treatment equipment according to claim 20, wherein said metal plate is inclined with respect to the bottom wall, and an angle formed between said metal plate and the bottom wall is less than 45 degrees.

22. (Previously Presented) The plasma treatment equipment according to claim 13, wherein the at least one of the electrode and the electrode shield being at the same DC potential as the chamber wall is the electrode, the electrode being shorted to the chamber wall by a metal plate.

23. (Twice Amended) A plasma treatment equipment having a chamber for performing plasma treatment, the plasma treatment equipment comprising:

a plasma excitation electrode to which a power for plasma excitation is supplied, the plasma excitation electrode being provided in the chamber;

a susceptor electrode that is opposed to the plasma excitation electrode provided in the chamber; and

an electrode shield of the susceptor electrode in the chamber, the electrode shield disposed adjacent to the susceptor electrode,

wherein at least one of the susceptor electrode and the electrode shield thereof has the same DC potential as that of a chamber wall of the chamber,

the susceptor electrode being an electrode into which a high frequency electric current based on the power for plasma excitation flows after passing through a plasma space,

the chamber wall of the chamber and at least one of the susceptor electrode and the electrode shield thereof are AC shorted to each other by a plurality of metal plates, each metal plate having a first end connected to a first short point on the shield and a second end connected to a second short point on an inner surface of the bottom wall of the chamber, and

the susceptor electrode is connected to the chamber wall of the chamber by a bellows provided in the chamber, the plurality of metal plates are disposed so as to be electrically parallel with the bellows.

Conclusion

Claims 1-23 are pending. For at least the reasons given above, the Applicants respectfully submit that the pending claims are allowable, or would be allowable if a terminal disclaimer were to be submitted.

The Examiner is respectfully requested to contact the undersigned in the event that a telephone interview would expedite consideration of the application.

Respectfully submitted,

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